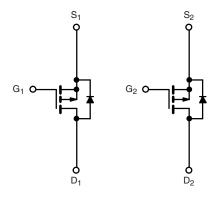


# **Dual P-Channel 20-V (D-S) MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)	
	0.013 at V <sub>GS</sub> = - 4.5 V	-7.5		
- 20	0.018 at V <sub>GS</sub> = - 2.5 V	-6.5	20 nC	
	0.032 at V <sub>GS</sub> = - 1.8 V	-5.0		



#### P-Channel MOSFET

P-Channel MOSFET

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



ROHS COMPLIANT HALOGEN FREE

### **APPLICATIONS**

- · Adaptor Switch
- High Current Load Switch
- Notebook

		TSSOP-8		
D <sub>1</sub> 1 S <sub>1</sub> 2 S <sub>1</sub> 3 G <sub>1</sub> 4	•		8 7 6 5	D <sub>2</sub> S <sub>2</sub> S <sub>2</sub> G <sub>2</sub>
_		Top View	-	

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	$V_{DS}$	- 20	V	
Gate-Source Voltage		V <sub>GS</sub>	± 12	
	T <sub>C</sub> = 25 °C		- 7.5	
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	$T_C = 70  ^{\circ}C$	I_	- 6.0	
Continuous Diain Gunent (1) = 130 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 5.4 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C		- 4.5 <sup>a, b</sup>	A
Pulsed Drain Current		I <sub>DM</sub>	- 30	A
Continuous Source Drain Diade Current	T <sub>C</sub> = 25 °C	,	- 4.1	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 2.1 <sup>a, b</sup>	
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 15	
Single-Pulse Avalanche Energy		E <sub>AS</sub>	11.25	mJ
	T <sub>C</sub> = 25 °C		5	
Maximum Dawar Dissination	T <sub>C</sub> = 70 °C		3.2	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	VV
	T <sub>A</sub> = 70 °C		1.6 <sup>a, b</sup>	
Operating Junction and Storage Temperature Rang	T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	38	50	°C/W	
Maximum Junction-to-Foot	Steady State	R <sub>th IF</sub>	20	25	- C/VV	

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s
- c. Maximum under steady state conditions is 85  $^{\circ}\text{C/W}.$
- d. Based on  $T_C = 25$  °C.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V		
V <sub>DS</sub> Temperature Coefficient	S Temperature Coefficient ΔV <sub>DS</sub> /T <sub>J</sub>			- 14.5		m\//°C		
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		2.8		mV/°C		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.4		- 1.0	V		
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA		
Zoro Coto Voltago Drain Correct	I <sub>DSS</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V	- 1		- 1			
Zero Gate Voltage Drain Current		V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C			- 10	μΑ		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, V_{GS} = -5 \text{ V}$	- 20			Α		
	, ,	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 7 A		0.013		1		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 6 A		0.018		Ω		
	- (- )	V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 3 A		0.032		1		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 9 A		40		S		
Dynamic <sup>b</sup>	-							
Input Capacitance	C <sub>iss</sub>			2380				
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		340		pF		
Reverse Transfer Capacitance	C <sub>rss</sub>			280				
Tatal Oats Observe	$Q_g$ $V_{DS} = -$	$V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_{D} = -5 \text{ A}$		45	70			
Total Gate Charge		20 20		20	35	nC		
Gate-Source Charge		V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 5 A		3.1				
Gate-Drain Charge	Q <sub>ad</sub>			8.4				
Gate Resistance	R <sub>q</sub>	f = 1 MHz	1.0	4.8	9.6	Ω		
Turn-On Delay Time	t <sub>d(on)</sub>			7	14			
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 2 $\Omega$ $I_D \cong$ - 5 A, $V_{GEN}$ = - 8 V, $R_q$ = 1 $\Omega$		9	18			
Turn-Off DelayTime	t <sub>d(off)</sub>			108	200			
Fall Time	t <sub>f</sub>	Ĭ		41	80			
Turn-On Delay Time	t <sub>d(on)</sub>			14	28	ns		
Rise Time	t <sub>r</sub>	$V_{DD} = -10 \text{ V, R}_{1} = 2 \Omega$		16	32			
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong -5 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		101	200	1		
Fall Time	t <sub>f</sub>	1		40	80			
<b>Drain-Source Body Diode Characteris</b>	stics							
Continous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 4.1			
Pulse Diode Forward Current	I <sub>SM</sub>	-			- 40	A		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 3 A, V <sub>GS</sub> = 0 V		- 0.66	- 1.2	٧		
Body Diode Reverse Recovery Time t <sub>rr</sub>		5 40		81	150	ns		
Body Diode Reverse Recovery Charge				150	300	nC		
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -2.3 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$		43		ns		
Reverse Recovery Rise Time	t <sub>b</sub>	†		38				

#### Notes:

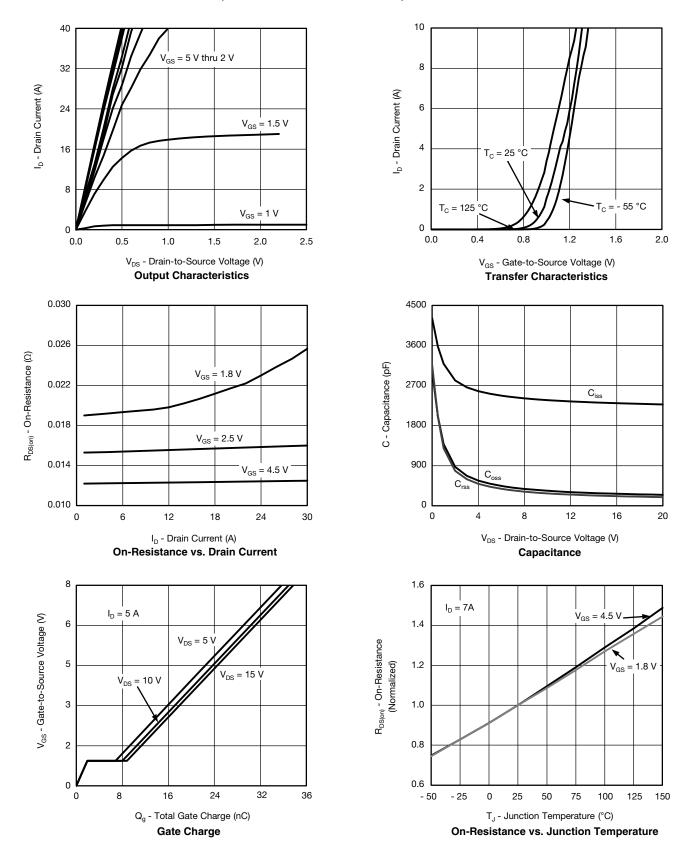
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- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

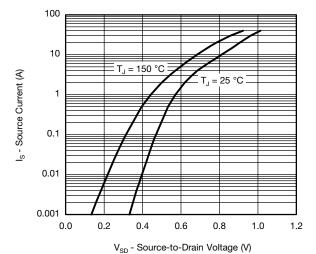
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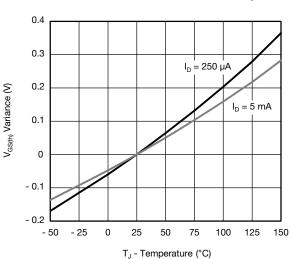


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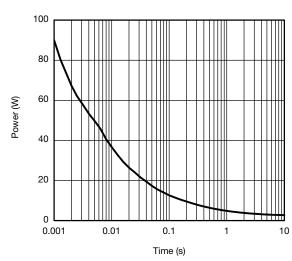
Source-Drain Diode Forward Voltage



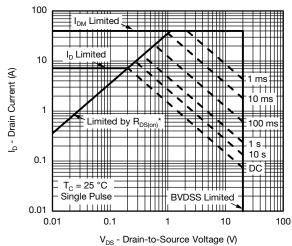
**Threshold Voltage** 

V<sub>GS</sub> - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



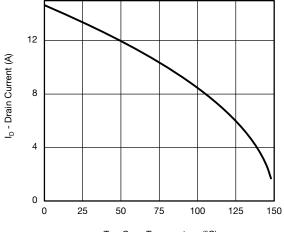
Single Pulse Power, Junction-to-Ambient



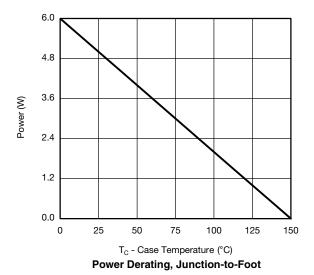
\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

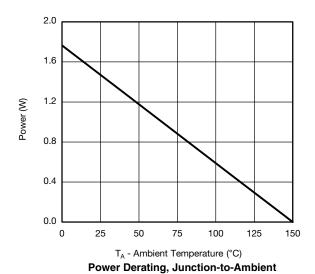
Safe Operating Area





T<sub>C</sub> - Case Temperature (°C) **Current Derating\*** 

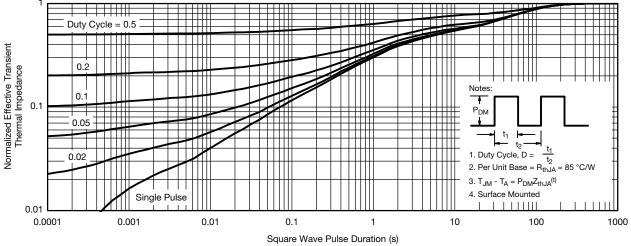




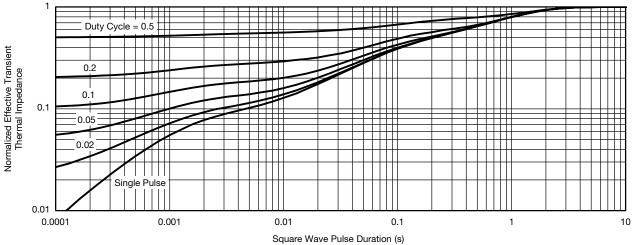
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<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



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